TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC7WH00FC

### **Dual 2-Input NAND Gate**

#### **Features**

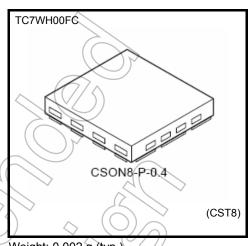
High speed operation  $: t_{pd} = 3.7 ns (typ.)$ 

at  $V_{CC}$  = 5 V,  $C_L$  = 15pF

:  $I_{CC} = 2\mu A \text{ (max)}$  at Ta = 25°C Low power dissipation High noise immunity :  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)

Operating voltage range :  $V_{CC} = 2 \text{ to } 5.5 \text{ V}$ 

5.5-V tolerant inputs



Weight: 0.002 g (typ.)

## Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>C</sub> C	-0.5 to 7.0	Vζ
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	>
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5 (Note1)	< <
Input diode current	l <sub>IK</sub>	-20	mA
Output diode current	lok	±20 (Note2)	mA
DC output current	lout	// ±25	mA
DC V <sub>CC</sub> /GND current	Icc	±50	mA
Power dissipation	PD	150 (Note3)	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1:High or Low State.

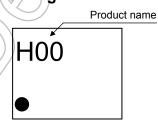
I<sub>OUT</sub> absolute maximum rating must be observed.

Note 2:Vout < GND, Vout > Vcc

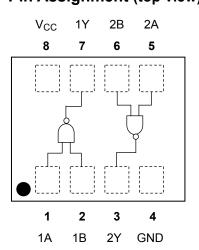
Note 3: Mounted on an FR4 board.

(25.4 mm × 25.4 mm × 1.6t, Cu Pad: 11.56 mm<sup>2</sup>)

### Marking



#### Pin Assignment (top view)



Start of commercial production 2005-06

# IEC Logic Symbol



# **Truth Table**

Α	В	Y
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

# **Operating Ranges**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	\ \ \
Input voltage	V <sub>IN</sub>	0 to 5.5	V
Output voltage	V <sub>OUT</sub>	0 to Vcc	V
Operating temperature	T <sub>opr</sub>	-40 to 85	◇°C (
Input rise and fall time	dt/dv	0 to 100 (V <sub>CC</sub> = $3.3 \text{ V} \pm 0.3 \text{ V}$ )	ns/V
		0 to 20 ( $V_{CC}$ = 5.0 V ± 0.5 V)	USFV

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### **Electrical Characteristics**

### **DC Characteristics**

Characteristic Symbol		Toot	condition		Ta = 25°C Ta = -40 to 85°C				Unit	
		Test condition		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Offic
High-level input voltage					1.5	_	7	1.5	_	
	V <sub>IH</sub>	V <sub>IH</sub> —		3.0 to 5.5	V <sub>CC</sub> × 0.7	_		V <sub>CC</sub> × 0.7		V
				2.0		40	0.5	_	0.5	V
Low-level input voltage V <sub>IL</sub> —		_	3.0 to 5.5	-		V <sub>CC</sub> × 0.3	_	V <sub>CC</sub> × 0.3		
				2.0	1.9	2.0	Y —	1.9	_	- V
			I <sub>OH</sub> = -50 μA	3.0	2.9	3.0	_	2.9	/	
high-level output voltage	V <sub>OH</sub>			4.5	4.4	4.5	_	4.4	K	
			I <sub>OH</sub> = -4 mA	3.0	2.58	> _	-6	2.48	_ <	
			I <sub>OH</sub> = -8 mA	4.5	3.94	_ <	/ _ (	3.80	) —	
Low-level output voltage			I <sub>OL</sub> = 50 μA	2.0	)	0.0	0.1	(F)	0.1	
				3.0		0.0	0:1	_	0.1	
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub>		4.5	_	0.0	0.1	_	0.1	
			I <sub>OL</sub> = 4 mA	3.0	_	$(\varphi/$	0.36	_	0.44	
			$I_{OL} = 8 \text{ mA}$	4.5			0.36	_	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5	v or GND	0 to 5.5	( - `	17	±0.1	_	±1.0	μА
Quiescent supply current	Icc	VIN = VCC	V <sub>IN</sub> = V <sub>CC</sub> or GND			<i>//</i> _	2.0	_	20.0	μΑ



# AC Characteristics (unless otherwise specified, Input: $t_{r} = t_{f} = 3 \text{ ns}$ )

Characteristic	Symbol		Test condition		Ta = 25°C			Ta = -40 to 85°C		Unit
			V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	
Propagation delay time	<sup>t</sup> pLH t <sub>pHL</sub>		3.3 ± 0.3	15	_	5.5	7.9	1.0	9.5	- ns
			3.5 ± 0.5	50	_	8.0	11.4	1.0	13.0	
			5.0 ± 0.5	15	_	3.7	5.5	1.0	6.5	
				50	_	5.2	7.5	1.0	8.5	
Input capacitance	C <sub>IN</sub>		_		_ ^	4((	7/10		10	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note 4)	_	19			_	pF

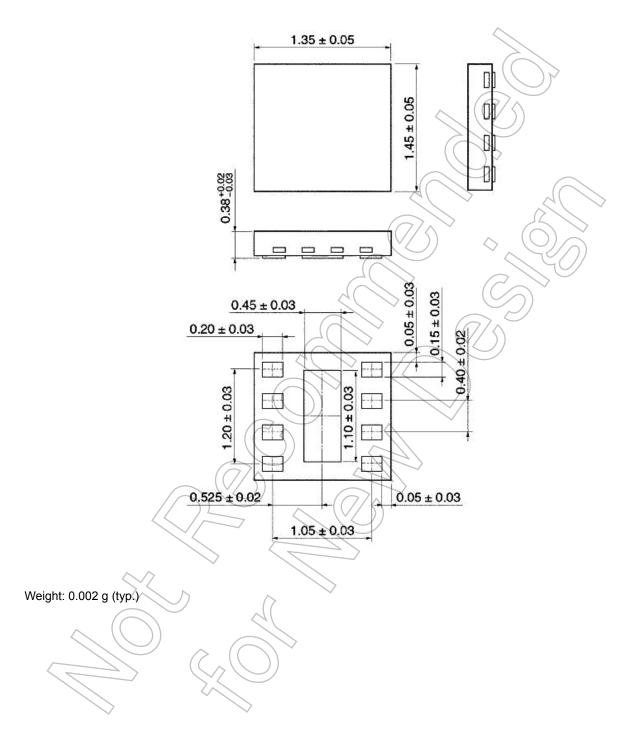
Note 4: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.



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### **Package Dimensions**

CSON8-P-0.4 Unit: mm



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